

OKI Semiconductor

ML9261/62

60-Bit Vacuum Fluorescent Display Tube Grid/Anode Driver

GENERAL DESCRIPTION

The ML9261/62 is a monolithic IC designed for directly driving the grid and anode of the vacuum fluorescent display (VFD) tube. The device contains a 60-bit shift register, a 60-bit register circuit, and 60 VFD tube driving circuits on a single chip.

Display data is serially stored in the shift register at the rising edge of a clock pulse.

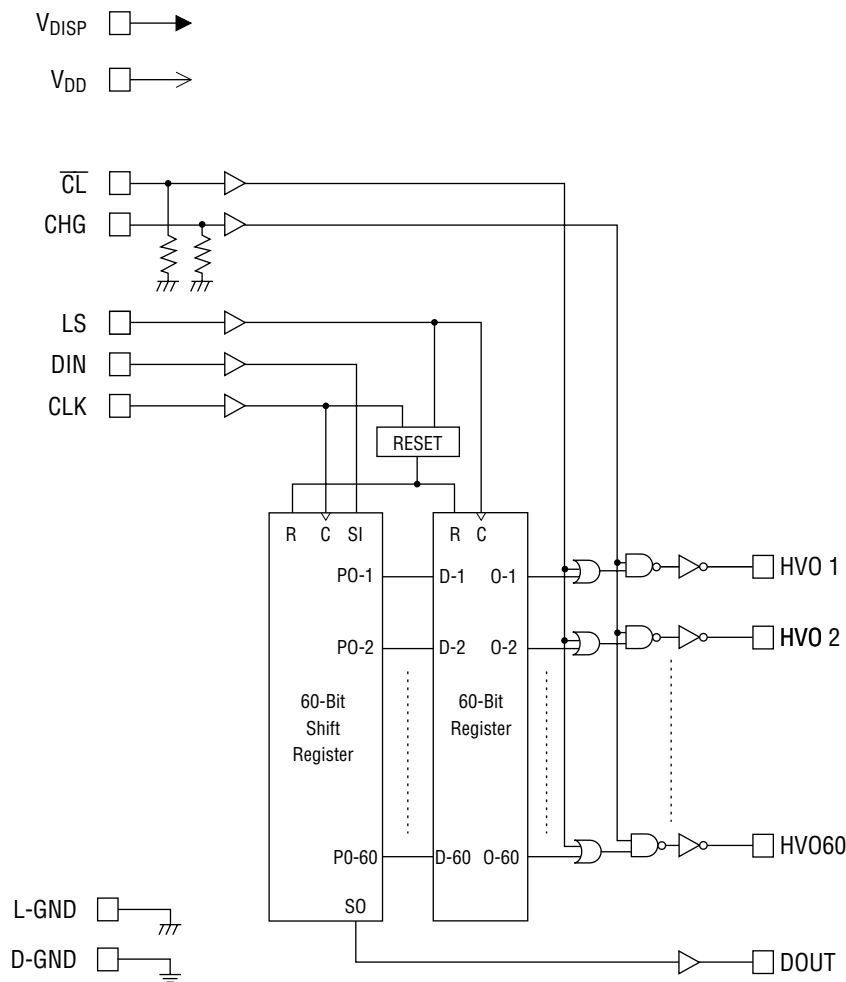
Setting the $\overline{\text{CL}}$ pin low allows all the VFD tube driving circuits to be driven low, which makes it possible to set the display blanking.

Also, setting both of the $\overline{\text{CL}}$ and CHG pins high allows all the VFD tube driving circuits to be driven high, which provides the easy testing of all lights after final assembly of a VFD tube panel.

FEATURES

- Logic Supply Voltage (V_{CC}): +3.3V $\pm$ 10% or +5.0V $\pm$ 10%
- Driver Supply Voltage (V_{HV}): +60V
- Driver Output Current
 - I_{OHVH1} (Only one driver output : "H") : -40mA (V_{DISP} =40V)
 - I_{OHVH2} (All the driver outputs : "H") : -120mA (V_{DISP} =40V)
 - I_{OHVL} :1mA
- Directly connected to VFD tube by using push-pull output (Pull-down resistors are not needed)
- Data Transfer Speed: 4MHz
- Package :
 - 70-pin plastic SSOP (SSOP70-P-500-0.80-K) (Product names : ML9261MB and ML9262MB)

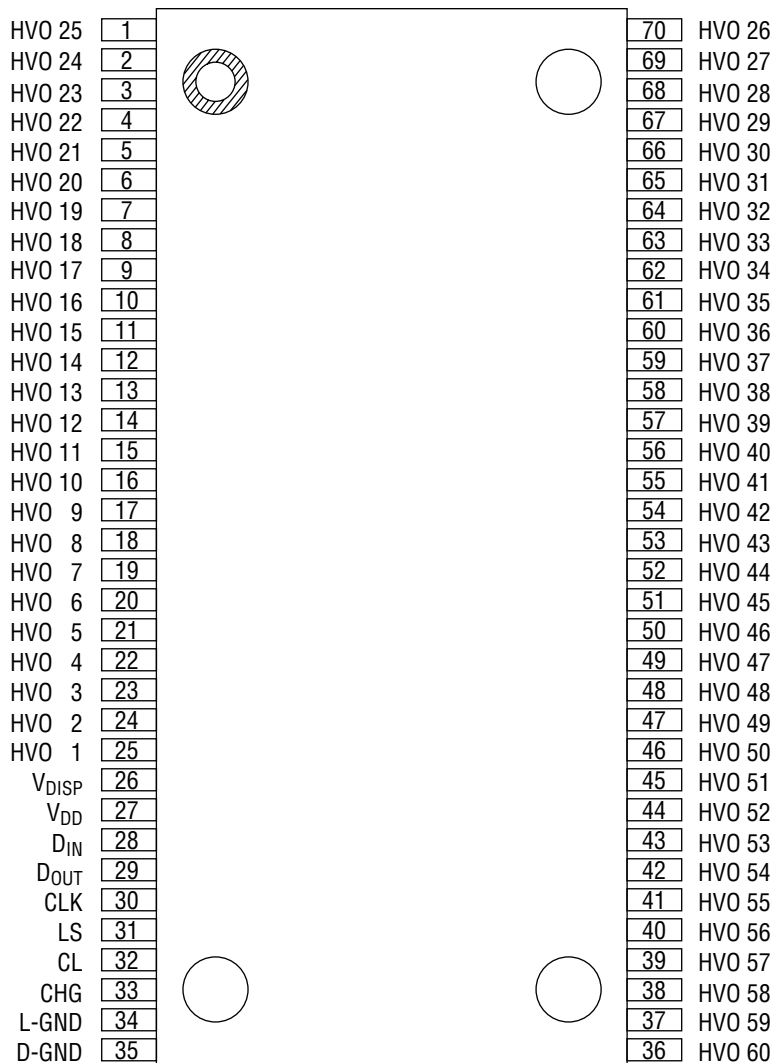
BLOCK DIAGRAM



INPUT AND OUTPUT CONFIGURATION

PIN CONFIGURATION (TOP VIEW)

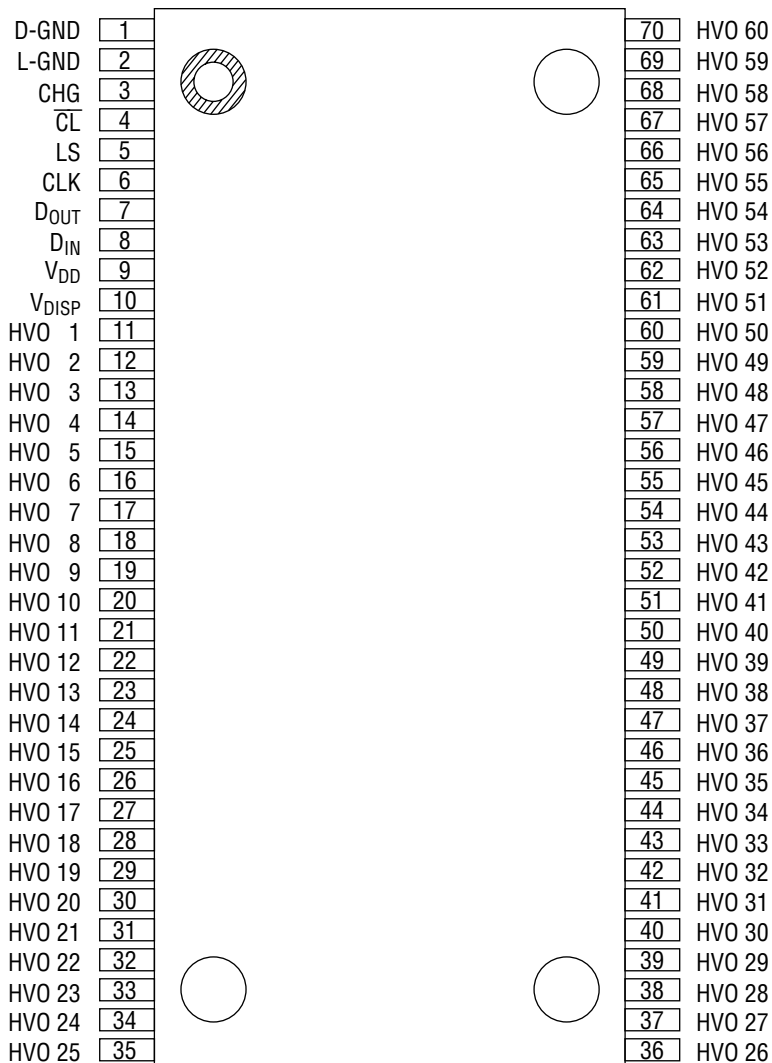
ML9261



70-Pin Plastic SSOP
(SSOP70-P-500-0.80-K)

PIN CONFIGURATION (TOP VIEW)

ML9262



70-Pin Plastic SSOP
(SSOP70-P-500-0.80-K)

PIN DESCRIPTION

Symbol	Type	Description
CLK	I	Shift register clock input pin. Shift register reads data from DIN while the CLK pin is low and the data in the shift register is shifted from one stage to the next stage at the rising edge of the clock.
DIN	I	Serial data input pin of the shift register. Display data (positive logic) is input in the DIN pin in synchronization with clock.
DOUT	O	Serial data output pin of the shift register. Data is output from the DOUT pin in synchronization with the CLK signal.
LS	I	Latch strobe input pin. The contents of the parallel outputs (PO1 to PO60) of the shift register are read at the rising edge of LS (edge-triggered). When the CLK rises while LS is high, the parallel outputs (PO1 to PO60) and latch outputs (O1 to O60) go low.
$\overline{\text{CL}}$	I	Clear input pin with a built-in pull-down resistor. The $\overline{\text{CL}}$ pin is normally set high. If the $\overline{\text{CL}}$ pin is high and the CHG pin is low, the driver outputs (HV01 to HV60) are in phase with the corresponding register outputs (O1 to O60). If the $\overline{\text{CL}}$ pin is high and the CHG pin is high, the driver outputs (HV01 to HV60) are high irrespective of the states of the register outputs. If the $\overline{\text{CL}}$ pin is set low, the driver outputs are driven low irrespective of the states of the CHG pin and register outputs. This allows display blanking to be set.
CHG	I	Input for testing (with a pull-down resistor). The $\overline{\text{CL}}$ pin is normally set low. If the CHG pin is low and the $\overline{\text{CL}}$ pin is high, the driver outputs (HV01 to HV60) are in phase with the corresponding register outputs (O1 to O60). If the CHG pin is low and the $\overline{\text{CL}}$ pin is low, the driver outputs (HV01 to HV60) are low irrespective of the states of the register outputs. If the CHG pin is set high, the driver outputs are driven high irrespective of the states of the register outputs. This provides the easy testing of all lights after final assembly.
VH01-60	O	High voltage driver outputs for driving VFD tube. If the $\overline{\text{CL}}$ pin is high and the CHG pin is low, the driver outputs are in phase with the corresponding register outputs (O1 to O60). The direct connection to the grid or anode of a VFD tube eliminates pull-down resistors.
V _{DISP}		Power supply pin for driver circuits of VFD tube
V _{DD}		Power supply pin for logic
D-GND		GND pin for driver circuits of a VFD tube. Since the D-GND is not be connected to L-GND, connect this pin to the external L-GND.
L-GND		GND pin for the logic circuits. Since the L-GND pin is not be connected to D-GND, connect this pin to the external D-GND.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Rating	Unit
Supply Voltage (1)	*1 V_{DD}	Applicable to logic supply pin	−0.3 to +6.5	V
Supply Voltage (2)	*1, *2 V_{DISP}	Applicable to driver supply pin	−0.3 to +6.5	V
Input Voltage	*1 V_{IN}	Applicable to all input pins	−0.3 to $V_{DD} + 0.3$	V
Output Voltage	*1 V_O	Applicable to DOUT	−0.3 to $V_{DD} + 0.3$	V
Output Current	I_O	Applicable to HV01 to 60	−50 to 0.0	mA
Withstand Output Voltage	*1, *2 V_{HVO}	Applicable to HV01 to 60	−0.3 to $V_{DISP} + 0.3$	V
Power Dissipation	P_D	$T_a \leq 25^\circ\text{C}$	860	mW
Package Thermal Resistance	*3 R_{j-a}	$T_a > 25^\circ\text{C}$	145	$^\circ\text{C}/\text{W}$
Storage Temperature	T_{STG}	—	−55 to +150	$^\circ\text{C}$

Notes: *1 Supply Voltage with respect to L-GND and D-GND

*2 Permanent damage may be caused if the voltage is supplied over the rating value.

*3 Package Thermal Resistance (between junction and ambient)

The junction temperature (T_j) expressed by the equation indicated below should not exceed 150°C .

$T_j = P \times R_{j-a} + T_a$ (P : Maximum power consumption)

RECOMMENDED OPERATING CONDITIONS-1**Unit Power Supply: 5.0V (Typ.)**

Parameter	Symbol	Condition	Min	Typ.	Max	Unit
Power Supply (1)	V_{DD}	—	4.5	5.0	5.5	V
Power Supply (2)	V_{DISP}	—	20	—	60	V
"H" Input Voltage	V_{IH}	Applicable to all inputs	$0.7V_{DD}$	—	—	V
"L" Input Voltage	V_{IL}	Applicable to all inputs	—	—	$0.3V_{DD}$	V
Driver Output Current	I_{OHVH1}	Only 1 output is ON.	—	—	−40	mA
	I_{OHVH2}	All outputs are ON.	—	—	−120	mA
CLK Frequency	f_{CLK}	—	—	—	4.0	MHz
Operating Temperature	T_{OP}	—	−40	—	+85	°C

RECOMMENDED OPERATING CONDITIONS-2**Unit Power Supply: 3.3V (Typ.)**

Parameter	Symbol	Condition	Min	Typ.	Max	Unit
Power Supply (1)	V_{DD}	—	3.0	3.3	3.6	V
Power Supply (2)	V_{DISP}	—	20	—	60	V
"H" Input Voltage	V_{IH}	Applicable to all inputs	$0.8V_{DD}$	—	—	V
"L" Input Voltage	V_{IL}	Applicable to all inputs	—	—	$0.2V_{DD}$	V
Driver Output Current	I_{OHVH1}	Only 1 output is ON.	—	—	−40	mA
	I_{OHVH2}	All outputs are ON.	—	—	−120	mA
CLK Frequency	f_{CLK}	—	—	—	4.0	MHz
Operating Temperature	T_{OP}	—	−40	—	+85	°C

ELECTRICAL CHARACTERISTICS

DC Characteristics-1

(V_{DD}=4.5 to 5.5V, V_{DISP}=40V, Ta=-40 to +85°C)

Parameter	Symbol	Applicable pin	Condition		Min	Typ.	Max	Unit
"H" Input Voltage	V _{IH}	All inputs	—		0.7V _{DD}	—	—	V
"L" Input Voltage	V _{IL}	All inputs	—		—	—	0.3V _{DD}	V
"H" Input Current	I _{IH1}	DIN, CLK, LS	V _{DD} =V _{IN} =5.5V		−1.0	—	+1.0	μA
	I _{IH2}	$\overline{\text{CL}}$, CHG	V _{DD} =V _{IN} =5.5V		5.0	—	80	μA
"L" Input Current	I _{IL}	All inputs	V _{DD} =5.5V, V _{IN} =0V		−1.0	—	+1.0	μA
Input Capacitance	C _{IN}	All inputs	Ta=25°C		—	15	—	pF
"H" Output Voltage	V _{OH1}	DOUT	I _{OH} =−0.1mA		V _{DD} −1	—	—	V
	V _{OH2}	HVO1 to 60	I _{OH} =−40mA		V _{DISP} −4	—	—	V
"L" Output Voltage	V _{OL1}	DOUT	I _{OL} =0.1mA		—	—	1.1	V
	V _{OL2}	HVO1 to 60	I _{OL} =1mA		—	—	3.0	V
Supply Current (Design Goal)	I _{DD1}	V _{DD}	No load	All inputs: "L"	—	—	10.0	μA
	I _{DD2}	V _{DD}		All inputs: "H"	—	—	10.0	μA
	I _{DISP1}	V _{DISP}		All inputs: "L"	—	—	10.0	μA
	I _{DISP2}	V _{DISP}		All inputs: "H"	—	—	10.0	μA

DC Characteristics-2

(V_{DD}=3.0 to 3.6V, V_{DISP}=40V, Ta=-40 to +85°C)

Parameter	Symbol	Applicable pin	Condition		Min	Typ.	Max	Unit
"H" Input Voltage	V _{IH}	All inputs	—		0.8V _{DD}	—	—	V
"L" Input Voltage	V _{IL}	All inputs	—		—	—	0.2V _{DD}	V
"H" Input Current	I _{IH1}	DIN, CLK, LS	V _{DD} =V _{IN} =3.3V		−1.0	—	+1.0	μA
	I _{IH2}	$\overline{\text{CL}}$, CHG	V _{DD} =V _{IN} =3.3V		2.0	—	50	μA
"L" Input Current	I _{IL}	All inputs	V _{DD} =3.3V,V _{IN} =0V		−1.0	—	+1.0	μA
Input Capacitance	C _{IN}	All inputs	Ta=25°C		—	15	—	pF
"H" Output Voltage	V _{OH1}	DOUT	I _{OH} =−0.1mA		V _{DD} −1	—	—	V
	V _{OH2}	HVO1 to 60	I _{OH} =−40mA		V _{DISP} −4	—	—	V
"L" Output Voltage	V _{OL1}	DOUT	I _{OL} =0.1mA		—	—	1.1	V
	V _{OL2}	HVO1 to 60	I _{OL} =1mA		—	—	3.0	V
Supply Current (Design Goal)	I _{DD1}	V _{DD}	No load	All inputs: "L"	—	—	10.0	μA
	I _{DD2}	V _{DD}		All inputs: "H"	—	—	10.0	μA
	I _{DISP1}	V _{DISP}		All inputs: "L"	—	—	10.0	μA
	I _{DISP2}	V _{DISP}		All inputs: "H"	—	—	10.0	μA

AC Characteristics-1

(V_{DD}=4.5 to 5.5V, V_{DISP}=40V, Ta=-40 to +85°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
CLK Pulse Width	t _W (CLK)		80	150	ns
DIN Setup Time	t _{SU} (D-CLK)		50	—	ns
DIN Hold Time	t _H (CLK-D)		50	—	ns
CLK-LS Setup Time	t _{SU} (CLK-LS)		50	—	ns
LS-CLK Setup Time	t _{SU} (LS-CLK)	During normal operation	50	—	ns
	t _{SU} (L-CLK)	At display data reset	50	—	ns
CLK-LS Hold Time	t _H (CLK-L)	At display data reset	50	—	ns
LS-CHG Setup Time	t _{SU} (LS-CHG)		50	—	ns
LS- $\overline{\text{CL}}$ Setup Time	t _{SU} (LS- $\overline{\text{CL}}$)		50	—	ns
LS Pulse Width	t _W (LS)		80	—	ns
CHG Pulse Width	t _W (CHG)		10	—	μs
$\overline{\text{CL}}$ Pulse Width	t _W ($\overline{\text{CL}}$)		10	—	μs
DOUT Delay time	t _{PD} , t _{PRD}	Load: 30pF	—	50	ns
Driver Output Delay Time	t _{DLH}	Load: 2.0kΩ resistance in parallel with 20pF capacitance	—	1.0	μs
	t _{DHL}		—	1.0	μs
	t _{DRHL}		—	1.0	μs
Driver Output Slew Rate	t _{TLH}	Load: 2.0kΩ resistance in parallel with 20pF capacitance	—	5.0	μs
	t _{THL}		—	5.0	μs

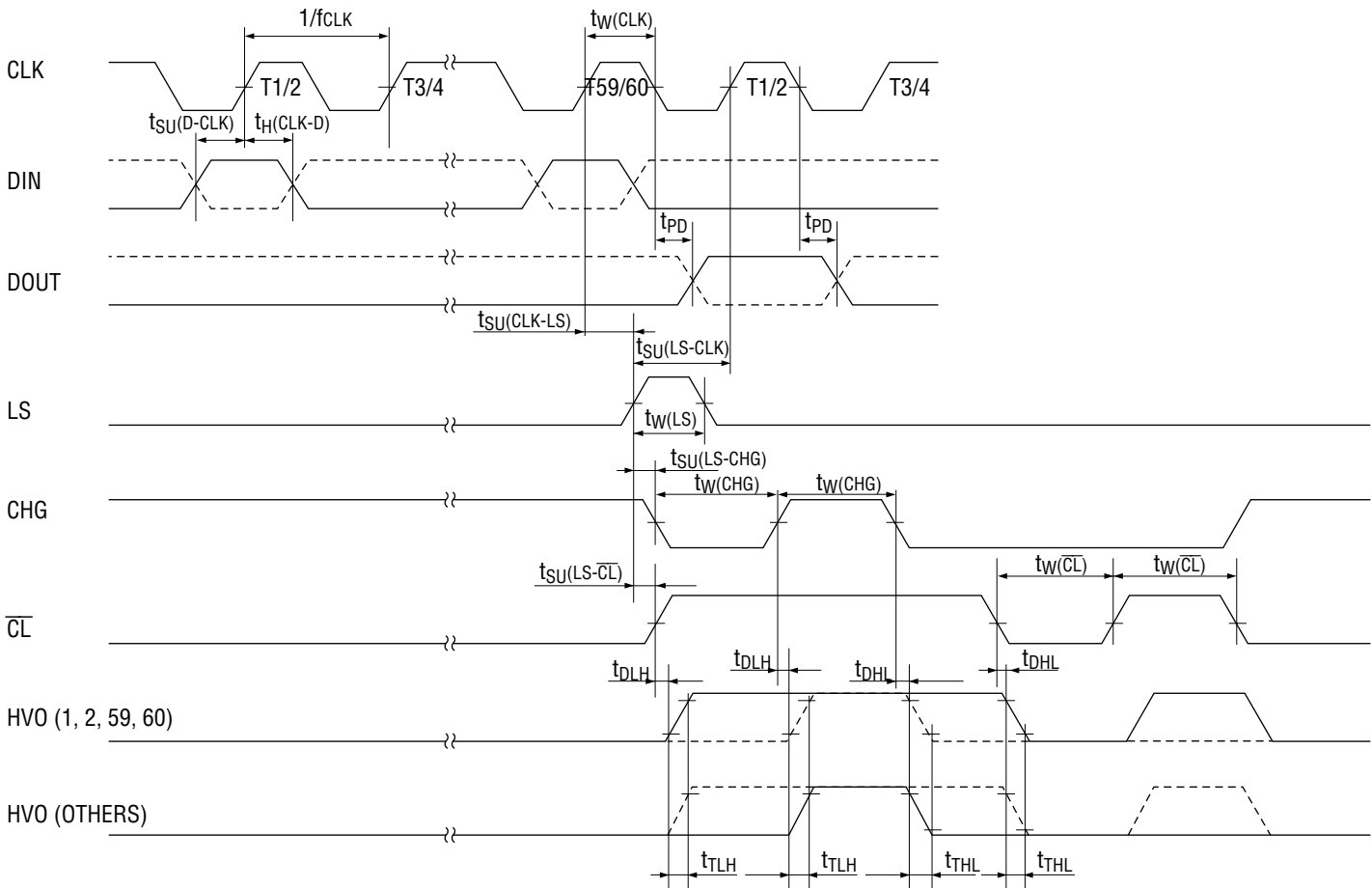
AC Characteristics-2

(V_{DD}=3.0 to 3.6V, V_{DISP}=40V, Ta=-40 to +85°C)

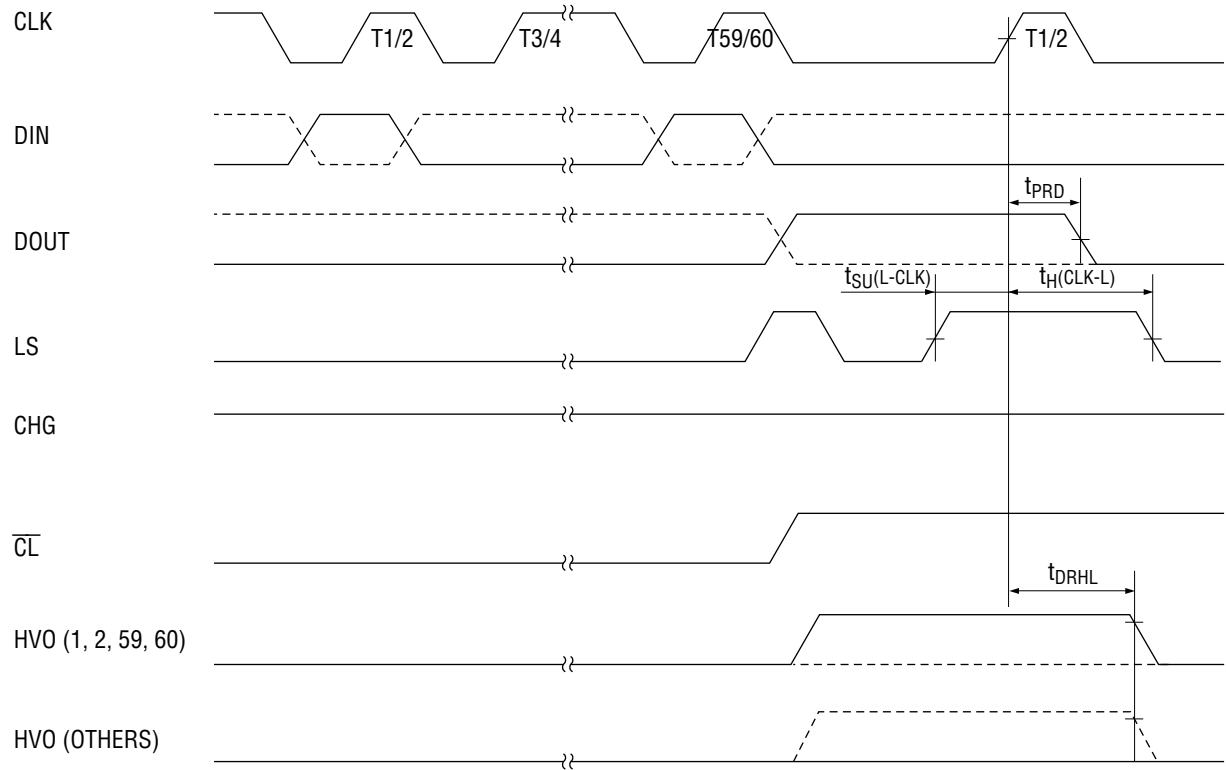
Parameter	Symbol	Condition	Min.	Max.	Unit
CLK Pulse Width	t _W (CLK)		80	150	ns
DIN Setup Time	t _{SU} (D-CLK)		50	—	ns
DIN Hold Time	t _H (CLK-D)		50	—	ns
CLK-LS Setup Time	t _{SU} (CLK-LS)		50	—	ns
LS-CLK Setup Time	t _{SU} (LS-CLK)	During normal operation	50	—	ns
	t _{SU} (L-CLK)	At display data reset	50	—	ns
CLK-LS	t _H (CLK-L)	At display data reset	50	—	ns
LS-CHG Setup Time	t _{SU} (LS-CHG)		50	—	ns
LS- $\overline{\text{CL}}$ Setup Time	t _{SU} (LS- $\overline{\text{CL}}$)		50	—	ns
LS Pulse Width	t _W (LS)		80	—	ns
CHG Pulse Width	t _W (CHG)		10	—	μs
$\overline{\text{CL}}$ Pulse Width	t _W ($\overline{\text{CL}}$)		10	—	μs
DOUT Delay time	t _{PD} , t _{PRD}	Load: 30pF	—	50	ns
Driver Output Delay Time	t _{DLH}	Load: 2.0kΩ resistance in parallel with 20pF capacitance	—	3.0	μs
	t _{DHL}		—	3.0	μs
	t _{DRHL}		—	3.0	μs
Driver Output Slew Rate	t _{TLH}	Load: 2.0kΩ resistance in parallel with 20pF capacitance	—	5.0	μs
	t _{THL}		—	5.0	μs

TIMING DIAGRAM

Normal Display Operation



Display Data Reset Operation



FUNCTIONAL DESCRIPTION

Display Data Reset

When the power is turned on, the shift register outputs (PO1 to PO60) and register outputs (O1 to O60) are indeterminate. Consequently the display of a VFD tube may flickers because unnecessary driver outputs go high. To prevent such flicker, it is required to perform the following operations.

1. Turn on the logic power supply while the $\overline{\text{CL}}$ input is kept low.
2. Set the LS input high.
3. Switch the CLK input from a low level to a high level at least once.

By performing the above operations, the shift register outputs (PO1 to PO60) and register outputs (O1 to O60) all are set low.

4. Enter display data.
5. Set the $\overline{\text{CL}}$ input high.

Data Transfer

Write display data by using a serial transfer.

Serial data is input in the shift register at the rising edge of a CLK input pulse.

When the LS input rises, display data is written in the latch.

Driver Output Control

1. To turn on or off driver outputs by using display data transfered into the shift register, set the $\overline{\text{CL}}$ input high and set the CHG input low.
2. To set all the driver outputs low, set the $\overline{\text{CL}}$ input low.
3. To set all the driver outputs high, set the $\overline{\text{CL}}$ input and CHG input high at a time.

Function Table

Shift register

Input			Shift Register Parallel Out					Output
CLK	DIN	LS	P01	P02		P059	P060	DOUT
	H	L	H	P01n		P058n	P059n	P059n
	L	L	L	P02n		P058n	P059n	P059n
	X	L	P01n	P02n		P059n	P060n	P060n
	X	H	L	L		L	L	L

X: Don't Care

P01n to P059n: P01 to P059 data just before CLOCK rises.

Register

Input		Shift Register Parallel Out	Latch Output
CLK	LS	P0m	Om
X		H	H
X		L	L
X		X	No Change
	H	L	L

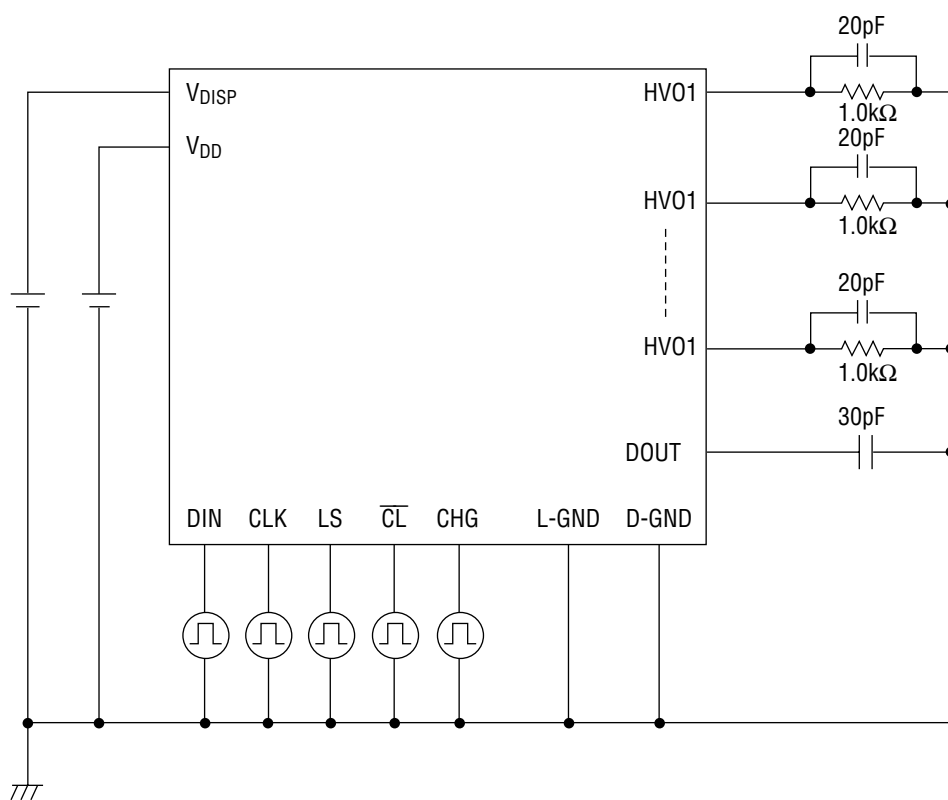
X: Don't Care, m: 1 to 60

Driver output

Input				Latch Output	Output
$\overline{CL}$	CHG	CLK	LS	Om	HV0m
H	L	X	X	H	H
H	L	X	X	L	L
H	H	X	X	X	H
L	X	X	X	X	L
X	X		H	L	L

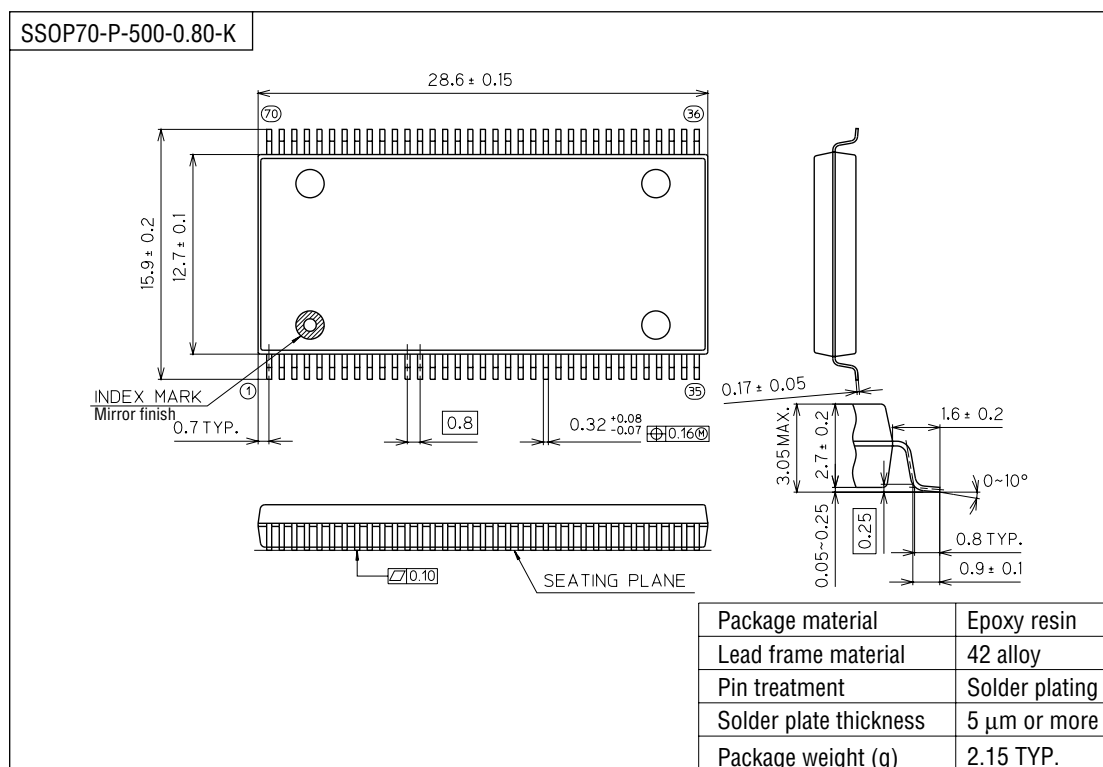
X: Don't Care, m: 1 to 60

Test circuit



PACKAGE DIMENSIONS

(Unit : mm)



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, SOJ, QFJ (PLCC), SHP and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

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